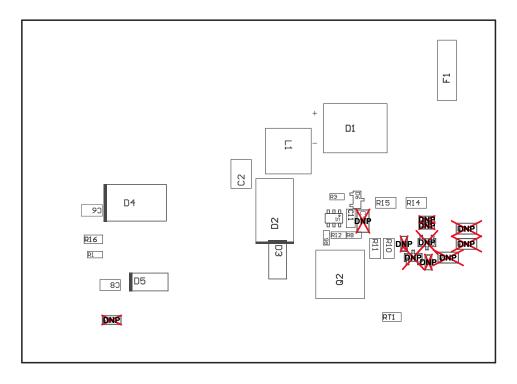


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP20545 REV: A	SVN REV: Not In VersionControl		
	TID #: N/A			
PLOT NAME = Top Assembly Drawing	GENERATED : 12/7/2016 5:2	4:45 PM TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP20545	REV: A	SVN REV	: Not In VersionControl
	TID #: N/A			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/7/20	D16 5:24:46	PM	TEXAS INSTRUMENTS

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